L Number	Hits	Search Text	DB	Time stamp
1	231	((205/323) or (205/199)).CCLS.	USPAT;	2004/07/08 21:07
			US-PGPUB; EPO; JPO; DERWENT;	·
2	287	((belt or (belt near3 (like or shape\$2))) same (ring or polygon)) same electrode	IBM_TDB USPAT; US-PGPUB; EPO; JPO; DERWENT;	2004/07/08 21:08
3	0	(((205/323) or (205/199)).CCLS.) and (((belt or (belt near3 (like or shape\$2))) same (ring or polygon)) same electrode)	IBM_TDB USPAT; US-PGPUB; EPO; JPO; DERWENT;	2004/07/08 20:32
4	58347	(belt or (belt near3 (like or shape\$2)) or ring or polygon) same electrode	IBM_TDB USPAT; US-PGPUB; EPO; JPO; DERWENT;	2004/07/08 21:32
5	5	(((205/323) or (205/199)).CCLS.) and ((belt or (belt near3 (like or shape\$2)) or ring or polygon) same electrode)	IBM_TDB USPAT; US-PGPUB; EPO; JPO; DERWENT;	2004/07/08 20:33
9	919	((205/323) or (205/199) or (438/678)).CCLS.	IBM_TDB USPAT; US-PGPUB; EPO; JPO; DERWENT;	2004/07/08 21:19
10	14	(((205/323) or (205/199) or (438/678)).CCLS.) and ((belt or (belt near3 (like or shape\$2)) or ring or polygon) same electrode)	IBM_TDB USPAT; US-PGPUB; EPO; JPO; DERWENT;	2004/07/08 21:08
100	5053	((204/193) or (204/194) or (204/196.28) or (204/199) or (204/237) or (204/238) or (204/256) or (204/270) or (204/277) or (204/279) or (204/297.05) or (204/297.13) or (204/668) or (204/669) or (204/671) or (204/272) or (205/323) or (205/199) or (4328/678)) CCLS	IBM_TDB USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/07/08 21:31
101	310	(438/678)).CCLS. (((204/193) or (204/194) or (204/196.28) or (204/199) or (204/237) or (204/238) or (204/256) or (204/270) or (204/277) or (204/279) or (204/297.05) or (204/297.13) or (204/668) or (204/669) or (204/671) or (204/272) or (205/323) or (205/199) or (438/678)).CCLS.) and ((belt or (belt near3)) (like or shape\$2)) or ring or polygon) same electrode)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/07/08 21:32
102	8262	(first and second and third and fourth) near2 electrod\$2	USPAT; US-PGPUB; EPO; JPO; DERWENT;	2004/07/08 21:33
103	5	((((204/193) or (204/194) or (204/196.28) or (204/199) or (204/237) or (204/238) or (204/256) or (204/270) or (204/277) or (204/256) or (204/270) or (204/277) or (204/279) or (204/297.05) or (204/297.13) or (204/668) or (204/669) or (204/671) or (204/272) or (205/323) or (205/199) or (438/678)).CCLS.) and ((belt or (belt near3 (like or shape\$2)) or ring or polygon) same electrode)) and ((first and second and third and fourth) near2 electrod\$2)	IBM_TDB USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/07/08 21:33
-	. 226	((205/323) or (205/199)).CCLS.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/07/08 20:30

-	13636	anodize or anodizing	USPAT; US-PGPUB; EPO; JPO;	2004/03/18 16:29
			DERWENT; IBM_TDB	0001/00/10 16 00
-	49	(((205/323) or (205/199)).CCLS.) and (anodize or anodizing)	USPAT; US-PGPUB; EPO; JPO;	2004/03/18 16:29
_	1348243	electrode	DERWENT; IBM_TDB USPAT;	2004/03/18 16:32
	1340243		US-PGPUB; EPO; JPO; DERWENT;	1001,00,10 10132
_	31	((((205/323) or (205/199)).CCLS.) and (anodize or anodizing)) and electrode	IBM_TDB USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/03/18 16:38
-	15	(("5856229") or ("5811348") or ("6190937") or ("6221738") or ("6382292") or ("6143628") or ("6306729") or ("6331208") or ("6613678") or ("6391743") or ("6211038") or ("6428620") or ("6376332") or ("5565084") or ("6258698")).PN.	USPAT	2004/03/18 16:41
-	3646500	apparatus	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/03/18 20:47
_	41465	electro near2 plating or electroless or electro near2 deposition	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/03/18 17:09
-	524	(anodize or anodizing) and (electro near2 plating or electroless or electro near2 deposition)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/03/18 17:09
_	244	((anodize or anodizing) and (electro near2 plating or electroless or electro near2 deposition)) and electrode	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/03/18 17:09
-	658264	first and second and third and fourth	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/07/08 21:33
-	80	(((anodize or anodizing) and (electro near2 plating or electroless or electro near2 deposition)) and electrode) and (first and second and third and fourth)	USPAT; US-PGPUB; EPO; JPO; DERWENT;	2004/03/18 17:11
-	60	apparatus and ((((anodize or anodizing) and (electro near2 plating or electroless or electro near2 deposition)) and electrode) and (first and second and third and fourth))	IBM_TDB USPAT; US-PGPUB; EPO; JPO; DERWENT;	2004/07/08 21:19
-	637	(anodize or anodizing) same apparatus	IBM_TDB USPAT; US-PGPUB; EPO; JPO; DERWENT;	2004/03/18 17:27
-	104298	(first and second and third and fourth) and electrode	IBM_TDB USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/03/18 19:32

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	F0	((anodize or anodizing) same apparatus) and	USPAT;	2004/03/18 19:29
_	58	((first and second and third and fourth) and	US-PGPUB;	2004/03/18 19:29
		electrode)	EPO; JPO;	
			DERWENT;	
			IBM_TDB	0004/00/10 10 01
-	138	((anodize or anodizing) same apparatus) same substrate	USPAT; US-PGPUB;	2004/03/18 19:31
		substrate	EPO; JPO;	
			DERWENT;	
			IBM_TDB	
-	387	(anodize or anodizing) near substrate	USPAT;	2004/03/18 19:31
l			US-PGPUB;	
			EPO; JPO; DERWENT;	ļ
			IBM TDB	
_	32230	(first and second and third and fourth) same	USPAT;	2004/03/18 20:07
		electrode	US-PGPUB;	
			EPO; JPO;	
			DERWENT;	
	8	((anodize or anodizing) near substrate) and	IBM_TDB USPAT;	2004/03/18 19:33
-	°	((first and second and third and fourth)	US-PGPUB;	2004/03/16 19:33
		same electrode)	EPO; JPO;	
		·	DERWENT;	
			IBM_TDB	
-	1348243	electrode	USPAT;	2004/03/18 20:07
			US-PGPUB; EPO; JPO;	
			DERWENT;	
			IBM TDB	
-	46	((anodize or anodizing) near substrate) same	USPAT;	2004/03/19 17:35
		electrode	US-PGPUB;	
			EPO; JPO; DERWENT;	
			IBM TDB	
-	30006	canon adj kabushiki adj kaisha	USPAT;	2004/03/18 20:24
			US-PGPUB;	
			EPO; JPO;	
			DERWENT; IBM TDB	
_	364	((anodize or anodizing) near substrate) not	USPAT;	2004/03/18 20:24
		(canon adj kabushiki adj kaisha)	US-PGPUB;	, ,
			EPO; JPO;	
			DERWENT; IBM TDB	
_	3646500	apparatus	USPAT;	2004/03/18 20:47
	5510500		US-PGPUB;	
			EPO; JPO;	
			DERWENT;	
_	103	(((anodize or anodizing) near substrate) not	IBM_TDB USPAT;	2004/03/18 20:47
-	103	(((ahodize or ahodizing) hear substrace) hot (canon adj kabushiki adj kaisha)) and	US-PGPUB;	2004/03/10 20:4/
		apparatus	EPO; JPO;	
			DERWENT;	
		(/#5555004#) (#50555000#)	IBM_TDB	2004/02/20 27 27
-	10	(("5565084") or ("5811348") or ("5856229") or ("6376332") or ("6428620")).PN.	USPAT; US-PGPUB;	2004/03/19 17:31
		OT (03/0332) OT (0420020) .FM.	EPO; JPO;	
			DERWENT;	
			IBM_TDB	
-	25	((belt near2 like) same (ring or polygon))	USPAT;	2004/07/08 20:31
		same electrode	US-PGPUB; EPO; JPO;	
			DERWENT;	
			IBM_TDB	
-	1514	(belt near2 like) same electrode	USPAT;	2004/03/19 17:34
			US-PGPUB;	
			EPO; JPO; DERWENT;	
			IBM TDB	

-	387	(anodize or anodizing) near substrate	USPAT; US-PGPUB;	2004/03/19 17:36
			EPO; JPO; DERWENT; IBM TDB	
-	0	((belt near2 like) same electrode) and ((anodize or anodizing) near substrate)	USPAT; US-PGPUB; EPO; JPO;	2004/03/19 17:36
			DERWENT; IBM_TDB	
-	4479	(first and second and third and fourth) near electrode	USPAT; US-PGPUB;	2004/03/19 17:37
			EPO; JPO; DERWENT; IBM TDB	
-	3	((anodize or anodizing) near substrate) and ((first and second and third and fourth)	USPĀT; US-PGPUB;	2004/03/19 17:37
		near electrode)	EPO; JPO; DERWENT; IBM_TDB	